

1-31-92

6/16/04



To the Honorable Commissioner of Patents and Trademarks
Please record the attached original documents or copy thereon.

102771452

BOX ASSIGNMENTS

1. Name of conveying party(ies): 1) Mitsuhiro YUASA	2. Name and address of receiving party(ies): Name: TOKYO ELECTRON LIMITED
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Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	Internal Address:
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3. Nature of conveyance:	Street Address: 3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 JAPAN
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<input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger	City:
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<input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name	State:	Zip Code:
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<input type="checkbox"/> Other:	Additional name(s) & Address(es) attached?
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Execution Date: February 29, 2004	<input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
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4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s): 10/772,304	B. Patent Number(s):
Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)

Authorized to be charged to deposit account

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

06/18/2004 MGETACHE 00000133 10772304
01 FC:8021 David W. Hill 40.00 DP
Registration No. 28,220

[Signature]
Signature
ERNEST F. CHAPMAN

June 16, 2004
Date

Total number of pages including cover sheet, attachments and documents: 2

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert
ASSIGNEE's
Name(s)
Address(es))

TOKYO ELECTRON LIMITED

3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of
Invention)

SEMICONDUCTOR FABRICATING APPARATUS

relating to International Patent Application PCT/JP _____/_____ and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date
of execution
of application,
if not
concurrent)

(a) executed on _____;

(b) filed on February 6, 2004,
Serial No. _____/_____;

(Finnegan, Henderson, Farabow Garrett &
Dunner L.L.P., Washington, D.C. 20005-3315
U.S.A.) is hereby authorized to insert in (b) the specified
data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

1) <u>Mitsuhiro Yuasa</u>	<u>Mitsuhiro Yuasa</u>	<u>February 29, 2004</u>
(SIGNATURE)	(TYPE NAME)	(DATE)
2) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
3) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
4) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
5) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
6) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
7) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)
8) _____	_____	_____
(SIGNATURE)	(TYPE NAME)	(DATE)